

2SD669(A)

/ Descriptions

WR0459I M M Q S Q æ M ç s ll 1

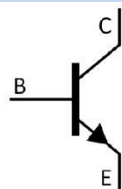
/ Features

лЬ 5VE97<+D,Ÿ

/ Applications

æ ç ç H I ' ð z

/ Equivalent Circuit



/ Pinning



X

X

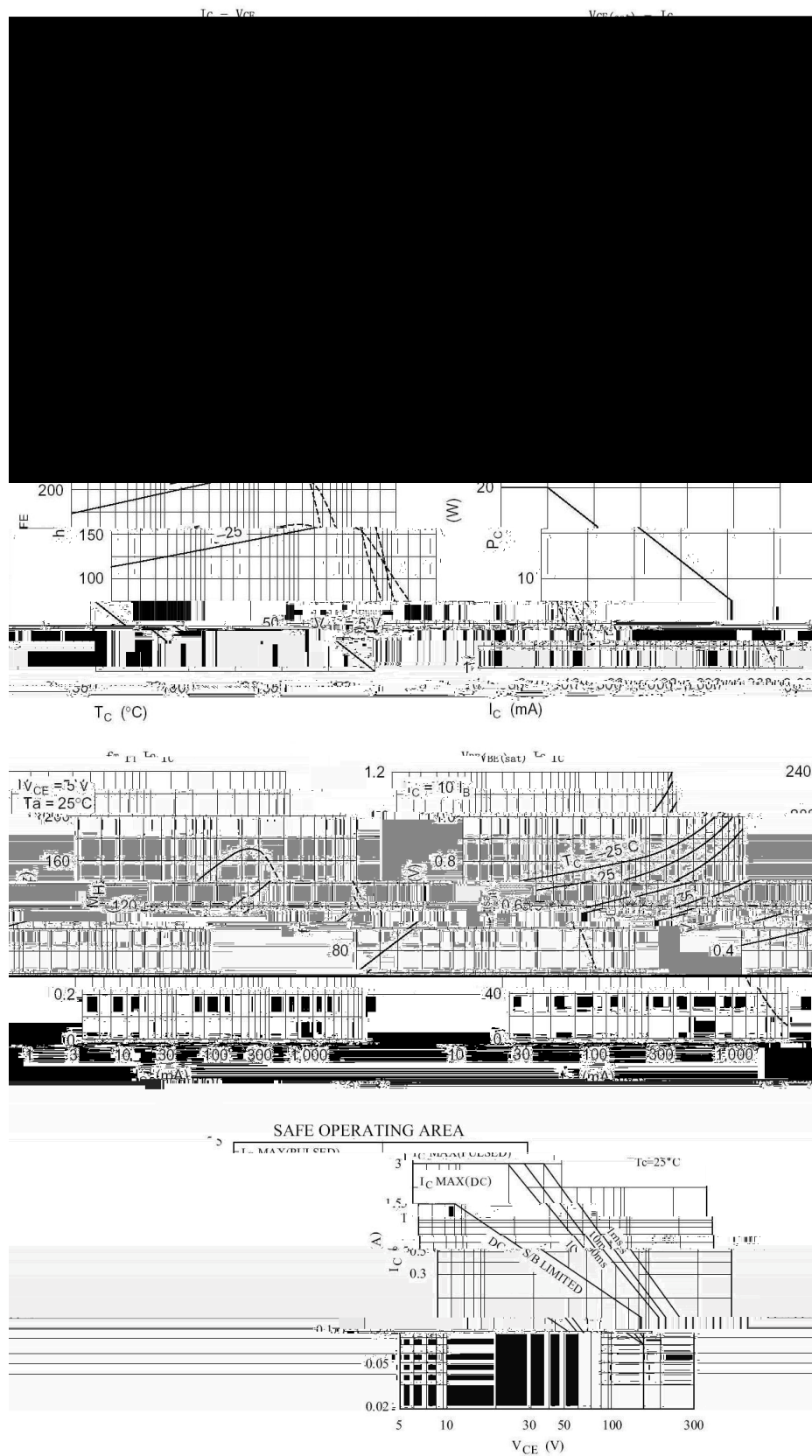
X

/ h_{FE} Classifications & Marking

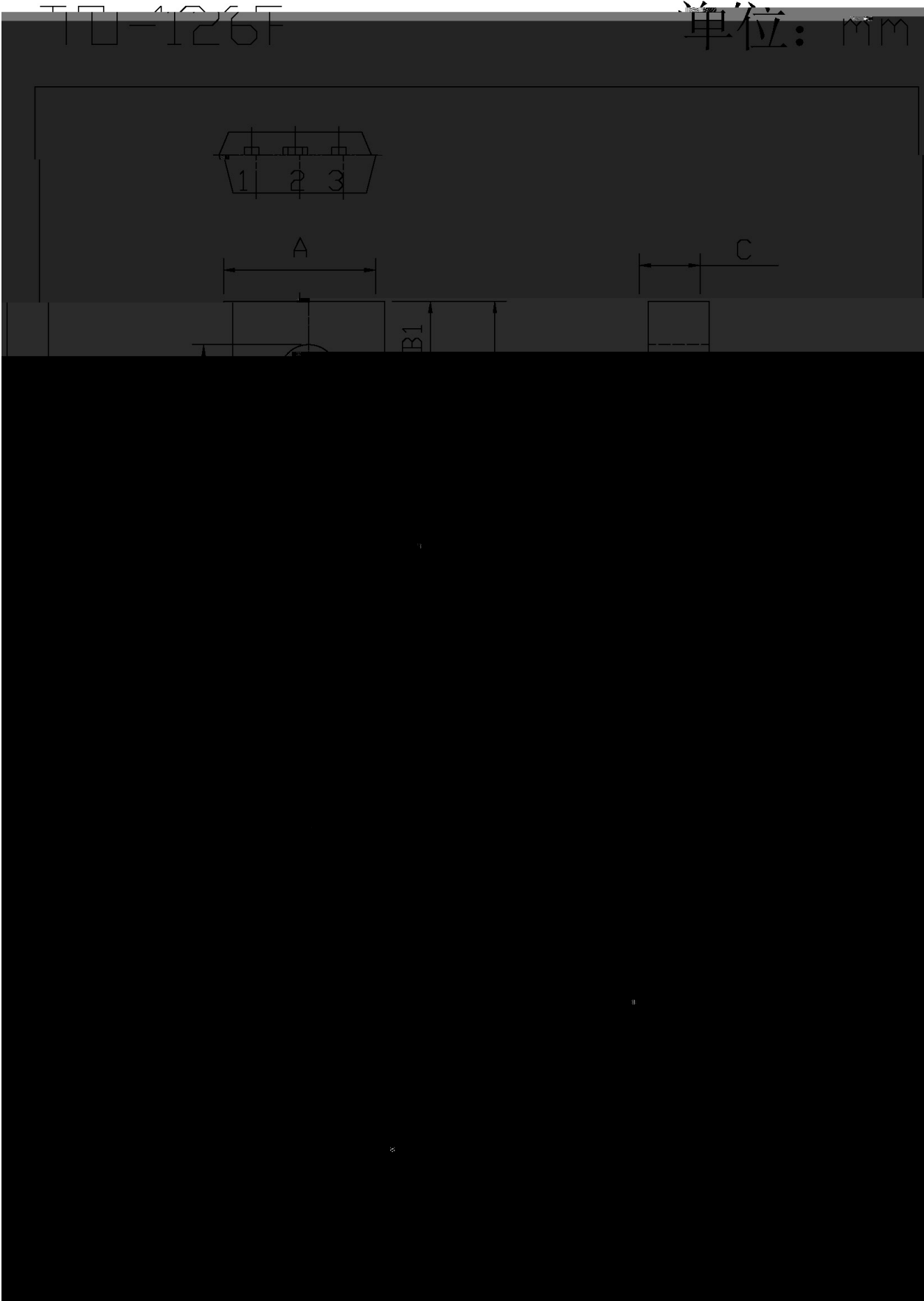
	~	~	~

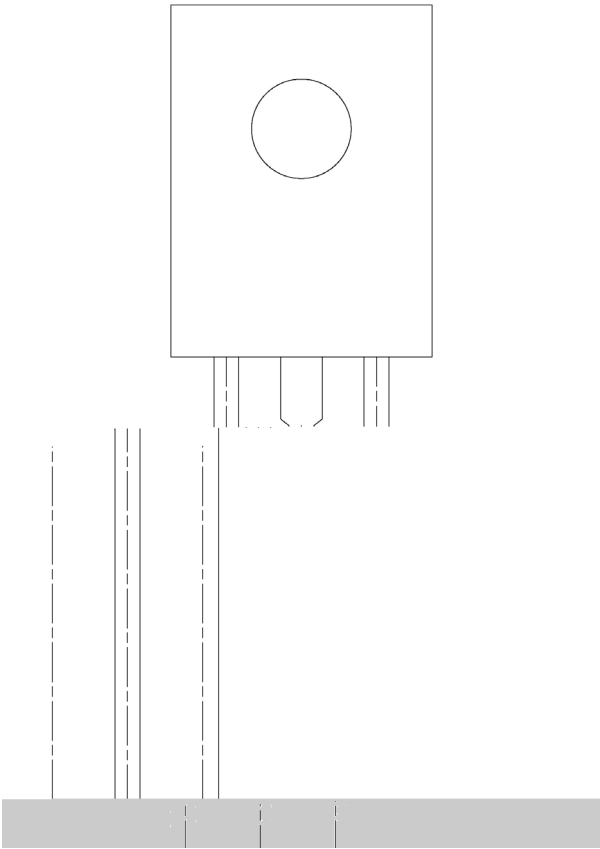
ƒ ˆ	ƒ N	ˆ ˆ	D ƒ

/ Electrical Characteristic Curve

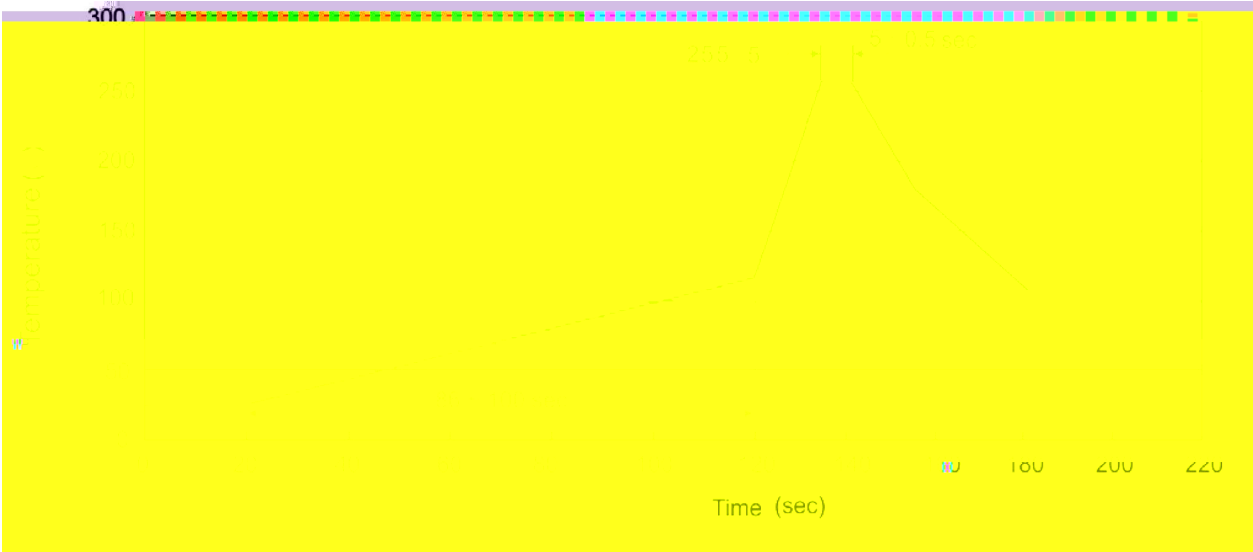


/ Package Dimensions





() / Temperature Profile for Dip Soldering(Pb-Free)



“X
□y K t i`H K
ŠÖ□y ° t i`H `Y/ΛK °
i` Y, o yK K t

t
° t °
t

/ Resistance to Soldering Heat Test Conditions

□yX ° t`H X °

/ Packaging SPEC.

“Q T Y

封装形式	包装数量					包装尺寸		
	只 套管	套管 盒	只 盒	盒 箱	只 箱	套管	盒	箱

„ 1 Y

封装形式	包装数量					包装尺寸		
	只 套管	套管 盒	只 盒	盒 箱	只 箱	套管	盒	箱

/ Notices